SDLS004

D2633 JANUARY 1981 - REVISED MARCH 1988

- Parallel Register Inputs ('LS592)
- Parallel 3-State I/O: Register Inputs/ Counter Outputs ('LS593)
- Counter has Direct Overriding Load and Clear
- Accurate Counter Frequency: DC to 20 MHz

description

The 'LS592 comes in a 16-pin package and consists of a parallel input, 8-bit storage register feeding an 8-bit binary counter. Both the register and the counter have individual positive-edge-triggered clocks. In addition, the counter has direct load and clear functions. A low-going $\overline{\text{RCO}}$ pulse will be obtained when the counter reaches the hex word FF. Expansion is easily accomplished for two stages by connecting $\overline{\text{RCO}}$ of the first stage to $\overline{\text{CCKEN}}$ of the second stage. Cascading for larger count chains can be accomplished by connecting $\overline{\text{RCO}}$ of each stage to CCK of the following stage.

The 'LS593 comes in a 20-pin package and has all the features of the 'LS592 plus 3-state I/O, which provides parallel counter outputs. The tables below show the operation of the enable (CCKEN, $\overline{\text{CCKEN}}$) inputs. A register clock enable ($\overline{\text{RCKEN}}$) is also provided.

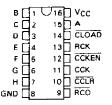
OUTPUT ENABLE CONTROL ('593 ONLY)

	G	G	A/Q _A thru H/Q _H
ı	L	L	input mode
	L	H	input mode
ı	Н	L	output mode
l	н	Н	input mode

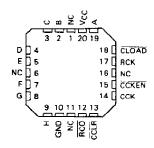
COUNTER CLOCK ENABLE CONTROL

CCKEN	CCKEN	EFFECT ON CCK
Ł	L	Enable
Ł	Н	Disable
Н	L	Enable
Н	н	Enable

SN54LS592 . . . J OR W PACKAGE SN74LS592 . . . N PACKAGE (TOP VIEW)

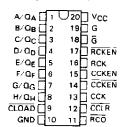


SN54LS592 . . . FK PACKAGE (TOP VIEW)

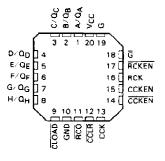


NC - No internal connection

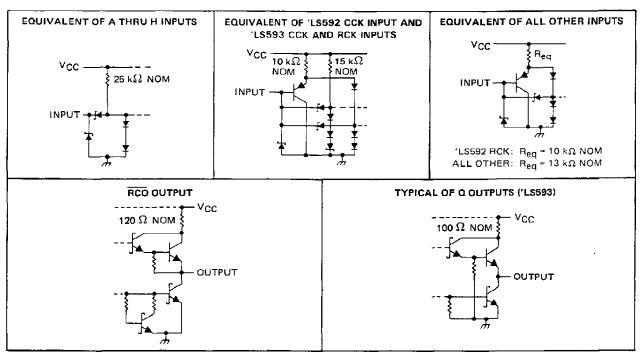
SN54LS593 . . . J OR W PACKAGE SN74LS593 . . . DW OR N PACKAGE (TOP VIEW)



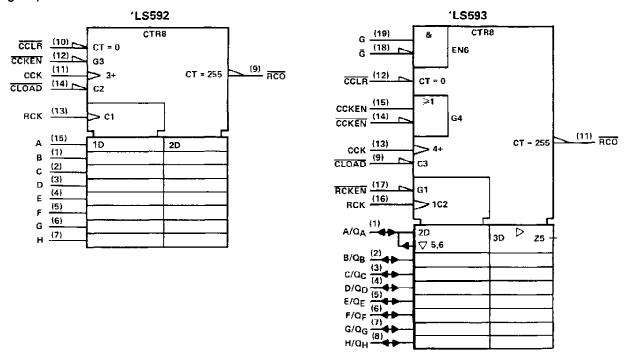
\$N54LS593 . . . FK PACKAGE (TOP VIEW)



schematics of inputs and outputs

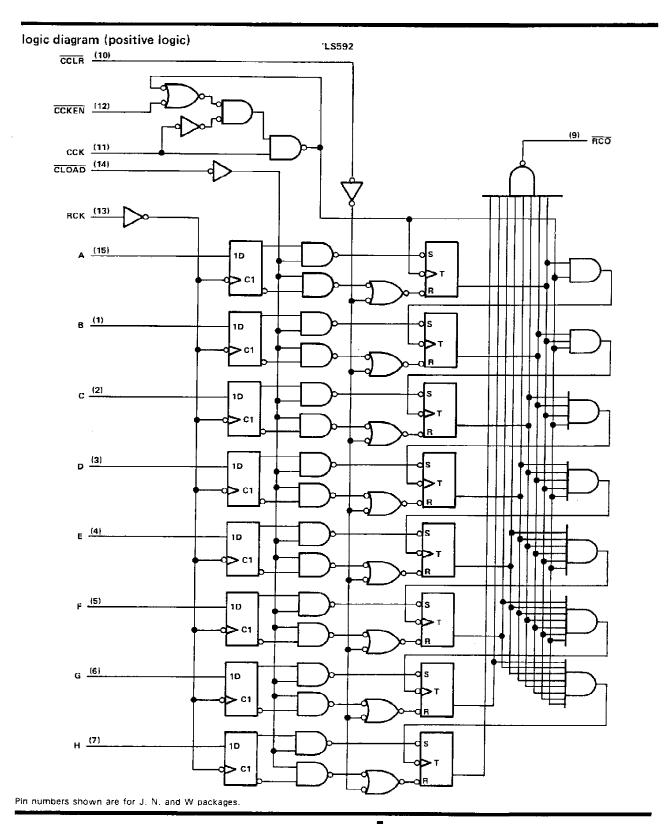


logic symbols†

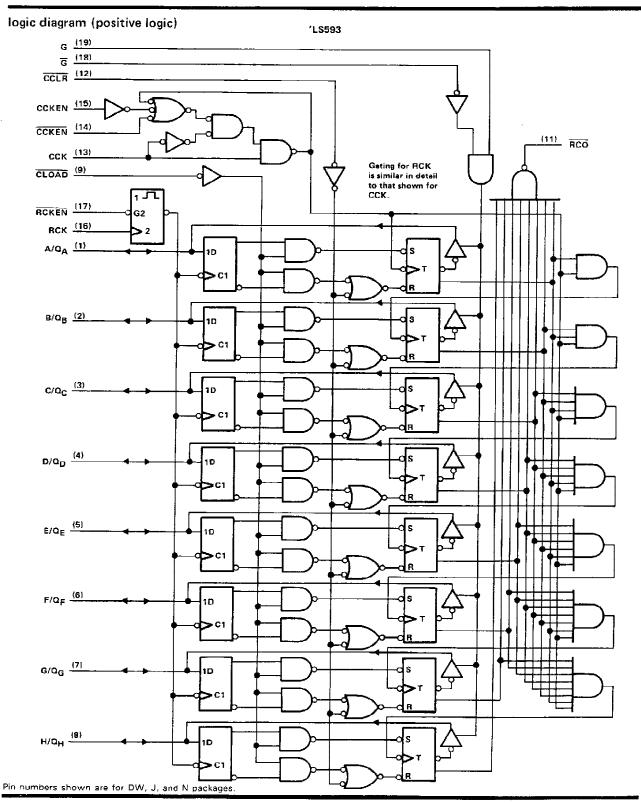


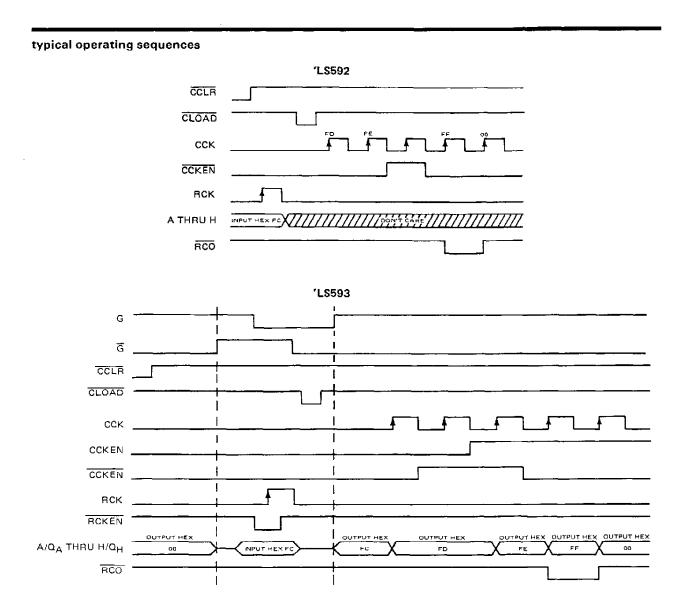
[†]These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, N, and W packages.





SN54LS593, SN74LS593 8-BIT BINARY COUNTERS WITH INPUT REGISTERS





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	
Input voltage (excluding I/O ports)	
Off-state output voltage (including I/O ports)	
Operating free-air temperature range: SN54LS592, SN54LS593 55°C to 125°C	
SN74LS592, SN74LS593	
Storage temperature range	

NOTE 1: Voltage values are with respect to the network ground terminal.

recommended operating conditions

			SN54LS'			SN74LS'				
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
v _{cc}	Supply voltage		4.5	5	5.5	4.75	5	5.25	٧	
V_{IH}	High-level input voltage		2			2			V	
v_{IL}	Low-level input voltage			•	0.7			8.0	V	
lan	High-level output current	RCO			- 1			- 1		
ГОН		Q 'LS593 only			- 1			- 2.6	mA	
101	Law-level output current	RCO			8			16	<u> </u>	
[†] OL	Cov-level botput cultent	Q 'LS593 only			12			24	mA	
fcck	Counter clock frequency		0		20	0		20	MHz	
tw (CCK)	Duration of counter clock p	ulse	25			25			ns	
tw (CCLR)	Duration of counter clear pu	ilse	20			20	-		ns	
tw (RCK)	Duration of register clock pulse					20			ns	
tw (CLOAD) Duration of counter load pulse			40			40			ns	
t _{su}	Register enable setup time	RCKEN low to RCK 1 , 'LS593	20			20			ns	
	Counter enable setup time	CCKEN low, 'LS592	30			30				
t _{su}	before CCK 1	CCKEN low or CCKEN high, 'LS593	30		30			ns		
		CCLR inactive before CCK 1	20			20			,	
^t su	Setup time	CLOAD inactive before CCK †	20			20			ns	
-su	octup time	RCK t before CLOAD t (see Note 2)	30			30				
		Data A thru H before RCK †	20			20				
t _h	Hold time	Data A thru H after RCK †	0			0				
*11	TIOTA CITIC	All others	0			0			ns	
TA	Operating free-air temperatu	re	- 55		125	0		70	°C	

NOTE 2: This time insures the data saved by RCK ↑ will also be loaded into the counter.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		T-07 004017	uavat	SN54LS'				ſ <u>.</u>		
		TEST CONDIT	MIN	TYP‡	MAX	MIN	TYP [‡]	MAX	UNIT	
Vik		VCC = MIN, II = -18 m	I _I = -18 mA			- 1.5			- 1.5	٧
	'LS593 Q	V _{CC} = MIN, V _{IH} = 2 V,	I _{OH} = -1 mA	2.4	3.2					1
∨он		V _{II} = MAX	I _{OH} = -2.6 mA				2.4	3.1		V
	RCO	AIT - MAY	I _{OH} = -1 mA	2.4	3.2		2.4	3.2		
	′LS593 Q		I _{OL} = 12 mA		0.25	0.4		0.25	0.4	
VOL	20000 0	V_{CC} - MIN, V_{IH} = 2 V,	I _{OL} = 24 mA					0.35	0.5	v
TUL	RCO	V _{IL} = MAX	I _{OL} = 8 mA		0.25	0.4		0.25	0.4	
	1.00		IOL = 16 mA					0.35	0.5	
^J OZH	'LS593 Q	$V_{CC} = MAX$, $V_{IH} = 2 V$,	VIL = MAX.	İ		20			20	μА
'OZH	E0000 (2	V _O = 2.7 V								٠,٠٠
lozu	'LS593 Q	V _{CC} = MAX, V _{IH} - 2 V,	$V_{IL} = MAX$			-0.4			-0.4	mΑ
'UZL	20000 0	V _O = 0.4 V				• • • • • • • • • • • • • • • • • • • •				
l ₁	'L\$593 Q	V _{CC} - MAX	V _I = 5.5 V			0.1			0.1	mΑ
'I Others		V = / V		0.1			0.1			
ЧH		$V_{CC} = MAX$, $V_{I} = 2.7 V$				20			20	μА
	ССК					-0.8			8.0 –	
	RCK LS592					-0.2			-0.2	
l _{IL}	′LS593	$V_{CC} = MAX$, $V_I = 0.4 V$				-0.B			-0.8	mA
	A thru H					-0.4		-0.4		
	Others					-0.2			-0.2	
los §	'LS593 Q	$V_{CC} = MAX, V_{C} = 0 V$		- 30		- 130	- 30		- 130	mA
.02	RCO	100		- 20		- 100	- 20		- 100	
	'LS592 CCH				40	60		40	60	
^I CC	ICCL	V _{CC} = MAX,			40	60		40	60	
	<u> Іссн</u>	All possible inputs grounded,	uts grounded,		47	70		47	70	mA
	'LS593 I _{CCL}	All outputs open			53	80		53	80	
	¹ccz				57	85	ŀ	57	85	

Teor conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $^{^{\}ddagger}$ All typical values are at V_{CC} = 5 V, T_A = 25 °C.

Not more than one output should be shorted at a time and the duration of the short-circuit should not exceed one second.

switching characteristics, VCC = 5 V, TA = 25 $^{\circ}$ C, (see note 3)

PARAMETER	FROM	то	TEST CONDITIONS			'LS592		'LS593			UNIT
PARAMETER	(INPUT)	(OUTPUT)			MIN	TYP	MAX	MIN	TYP	MAX	CIVIT
f _{max}	CCK	RCO	$R_L = 1 k\Omega$,	CL = 30 pF	20	35		20	35		MHz
¹₽LH	CCK1	O.							14	21	ns
^t PHL.	CCK+	Q							26	39	ns
īÞLH	CLOAD +	Q							34	51	ns
tPHL	CLOAD +	Ω	R _L = 667 Ω,						28	42	ns
^t PHL	CCLR +	۵		Cլ = 45 pF					25	38	ns
^t PZH	G t	Ω	1						31	47	ns
[†] PZL	Gt	Q	7		L				27	40	ns
^t PZH	G↓	a						29	45	ns	
^t PZL	Gι	a							31	47	ns
†PHZ	G t	a		0 5 5					33	50	ns
tPLZ ·	G +	a	D . CCT 0						35	52	ns
^t PHŻ	<u>G</u> ↑	Q	RL = 667 Ω,	C[-5₽F					26	39	ns
^t PLZ	Ğt	Q.	1						28	42	ns
[†] PLH	CCK t	RÇO			15	23		14	21	ns	
[†] PHL	CCK 1	RCO	1			20	30		20	30	ns
tPLH	CLOAD +	ACO	R _L = 1 kΩ,	$C_L = 30 pF$		31	47		31	47	ns
tPHL.	CLOAD :	RCO				27	41		27	41	ns
^t PLH	CCLR +	ACO				30	45		30	45	ns
^t PLH	RCK 1	RCO	_	C _L = 30 pF		35	53		42	63	ns
tPHL.	RCK †	RCO	CLOAD = L			30	45		33	50	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

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